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August 18th, 2025

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717528743\_Letter\_of\_Confirmation\_SW\_Component\_Qualification\_JACINTO\_SCI\_V1.0.

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Re: Confirmation of software component qualification for JACINTO SCI for J721E, J721S2, J7200, J784S4 and J742S2

To Whom It May Concern,

Texas Instruments Incorporated requested TÜV SÜD Rail GmbH to assess the SCI component of JACINTO version 11.00.00 for the variants J721E, J721S2, J7200, J784S4 and J742S2 as described in the technical report TD105397T version 1.0, up to ASIL D.

The component has not been developed according to the ISO 26262, but rather the suitability of the evidence and work products delivered by TI to allow integrators to perform a qualification according to ISO 26262-8:2018 Clause 12 was assessed.

The assessment has been finalized with a positive conclusion as described in the technical report mentioned above. The related project numbers are 717528743, 717532585.

Kind regards

Management

Functional Safety Expert



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